

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



Applicant(s):

Robert F. Wallace

Title:

Semiconductor Package Using Terminals Formed on a

Conductive Layer of a Circuit Board

Application No.:

09/866,022

Filing Date:

May 24, 2001

Examiner:

Roy Karl Potter

Group Art Unit:

2822

Docket No.:

**SNDK.112US2** 

Conf. No.:

6172

Mail Stop RCE Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## REQUEST FOR CONTINUED EXAMINATION (RCE)

Dear Sir:

This is a Request for Continued Examination (RCE) under 37 C.F.R. § 1.114 of the above-identified application.

Please consider the Petition Under 37 C.F.R. § 1.313(c) and Supplemental Information Disclosure Statement, which are being filed herewith. The RCE fee required under 37 C.F.R. § 1.17(e) is authorized in an accompanying transmittal letter.

Please contact the undersigned attorney with any questions concerning this request or the above-identified patent application.

Certificate of Mailing Under 37 CFR 1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope address to: Mail Stop RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 24, 2004.

Franklin Dyer

Respectfully submitted,

Gerald P. Parsons Reg. No. 24,486